DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

POLISHING SLURRY FOR SEMICONDUCTOR PLANARIZATION

the specificatio	n of which is attached hereto un	less the following is chec	ked		
was filed or International A	nas United States Applica pplication Number <u>PCT/JP200</u>	ation Number and v 4/011549 and was amend	was filed on <u>August 11, 200</u> ed on(if applicable).	4 as PCT	
I hereby state the claim(s), as am	hat I have reviewed and underst ended by any amendment referr	and the contents of the above.	ove-identified specification,	including the	
I acknowledge Regulations, §	the duty to disclose information 1.56.	which is material to pate	ntability as defined in Title	37, Code of Federal	
I hereby claim for patent or in inventor's certi	foreign priority benefits under I ventor's certificate listed below ficate having a filing date befor	Fitle 35, United States Coo and have also identified be that of the application for	de, § 119 (a) – (d) of any for below any foreign applicatio or which priority is claimed.	reign application(s) n for patent or	
				Priority Claimed	
(List prior foreign applications. See note A)	P2003-293438	Japan	14/08/2003	⊠ Yes □ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
	Oll	(6)		☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
				☐ Yes ☐ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
				∏ Yes ∏ No	
	(Number)	(Country)	(Day/Month/Year Filed)		
(See note B)	See attached list for additional	prior foreign applications			
insofar as the s	the benefit under Title 35, Unit ubject matter of each of the clai provided by the first paragraph lich is material to patentability a ecame available between the fill lication.	ms of this application is n of Title 35. United States	ot disclosed in the prior Un Code 8 112 Lacknowleds	ited States application	
a:- : na			Stat	tus	
(List prior U.S. Applications)			Patented Pending Abandoned		
	(Application Serial No.)	(Filing Date)			
	(Application Serial No.)	(Filing Date)	☐ Patented ☐ Pend	ding Abandoned	
			☐ Patented ☐ Pend	Patented Pending Abandoned	
	(Application Serial No.)	(Filing Date)			
		(Eii: D.)	Patented Pend	ding	
	(Application Serial No.)	(Filing Date)			

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number: 38834

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or first inventor (given na		Kanshi CHINONE			
	Inventor's signature Kanshi Ch		y 8, 2006			
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	Full name of second inventor (given name,					
	Inventor's signature	Date				
	Residence	Citizenship				
	Post Office Address					
	Full name of third inventor (given name, fa	amily name)	****			
	Inventor's signature	Date				
	Residence	Citizenship				
	Post Office Address					
	Full name of fourth inventor (given name,					
	Inventor's signature	Date				
	Residence	Citizenship				
	Post Office Address					
	-					
	Full name of fifth inventor (given name, family name)					
	Inventor's signature	Date				
	Residence	Citizenship				
	Post Office Address					
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	Full name of sixth inventor (given name, family name)					
	Inventor's signature	Date				
	Residence	Citizenship				
	Post Office Address					